

TLP591B

Unit: mm

Telecommunications
 Programmable Controllers
 MOS Gate Drivers
 MOSFET Gate Drivers

The TOSHIBA TLP591B consists of an infrared emitting diode optically coupled to a series-connected photo-diode array in a six-lead plastic DIP package.

The TLP591B is suitable for MOS FET gate drivers.

The TLP591B has an internal shunt resistor to optimize switching speed.

- UL-recognized: UL 1577, File No.E67349

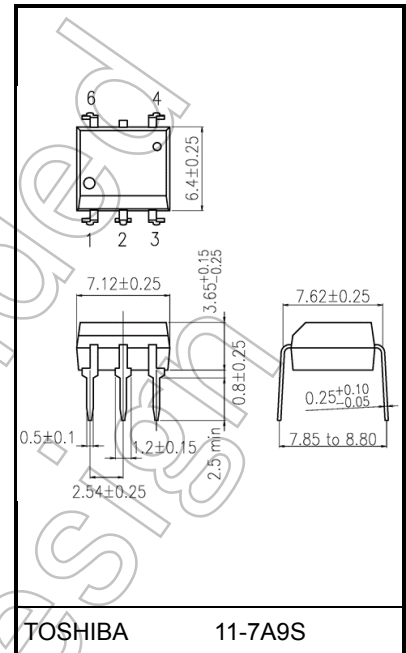
Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
LED	Forward current	IF	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔIF /°C	-0.5	mA /°C
	Pulse forward current (100 μs pulse, 100 pps)	IFP	1	A
	Reverse voltage	VR	3	V
	Diode power dissipation	PD	100	mW
	Diode power dissipation derating (Ta ≥ 25°C)	ΔPD /°C	-1.0	mW /°C
	Junction temperature	Tj	125	°C
Detector	Forward current	IFD	50	μA
	Reverse voltage	VRD	10	V
	Output power dissipation	PO	0.5	mW
	Junction temperature	Tj	125	°C
Storage temperature range		Tstg	-55 to 125	°C
Operating temperature range		Topr	-40 to 85	°C
Lead soldering temperature (10 s)		Tsol	260	°C
Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)		BVs	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

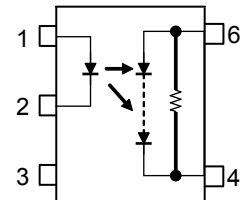
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two terminal device: Pins 1, 2 and 3 shorted together, and pins 4 and 6 shorted together.



Weight: 0.39 g (typ.)

Pin Configuration (top view)



- 1 : Anode(LED)
- 2 : Cathode(LED)
- 3 : NC
- 4 : Cathode
- 6 : Anode

Start of commercial production
 1990-11

Recommended Operating Conditions

Characteristic	Symbol	Min	Typ.	Max	Unit
Forward current	I_F	—	20	25	mA
Operating temperature	T_{opr}	-25	—	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V_F	$I_F = 10 \text{ mA}$	1.2	1.4	1.7	V
	Reverse current	I_R	$V_R = 3 \text{ V}$	—	—	10	μA
	Capacitance	C_T	$V = 0 \text{ V}, f = 1 \text{ MHz}$	—	30	60	pF
Detector	Forward voltage	V_{FD}	$I_{FD} = 10 \mu\text{A}$	—	7	—	V
	Reverse current	I_{RD}	$V_{RD} = 10 \text{ V}$	—	7	—	μA

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Open voltage	V_{OC}	$I_F = 20 \text{ mA}$	7	8	—	V
Short Current	I_{SC}	$I_F = 20 \text{ mA}$	24	40	—	μA

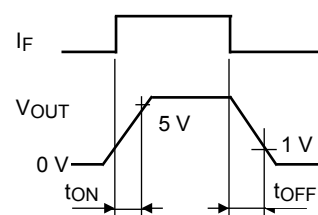
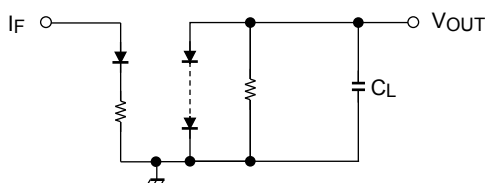
Isolation Characteristics (Ta = 25°C)

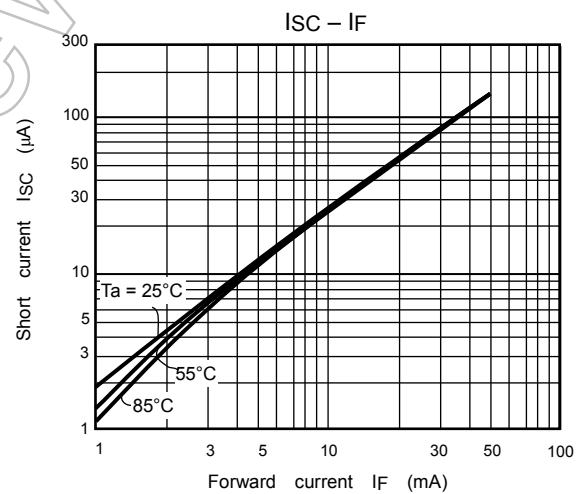
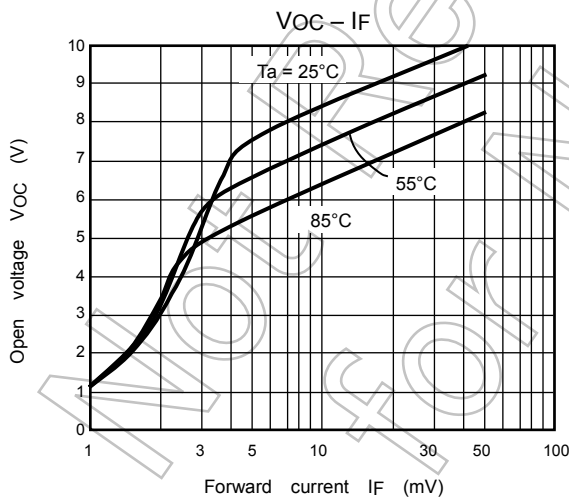
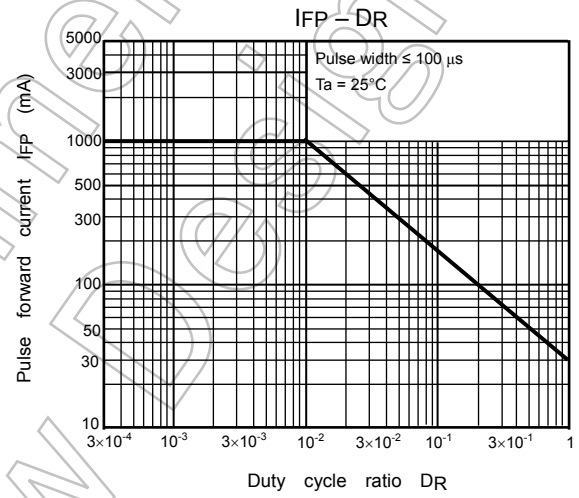
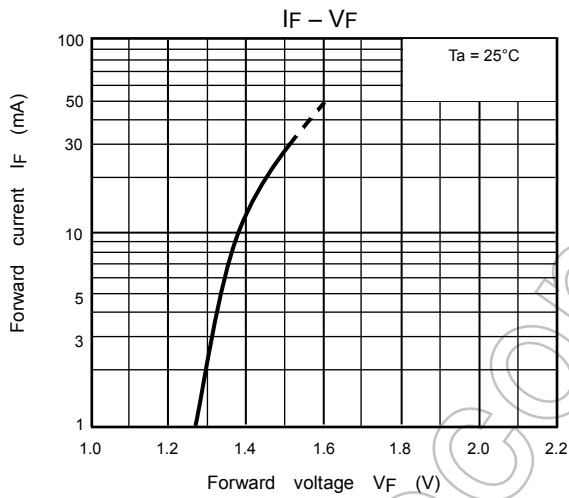
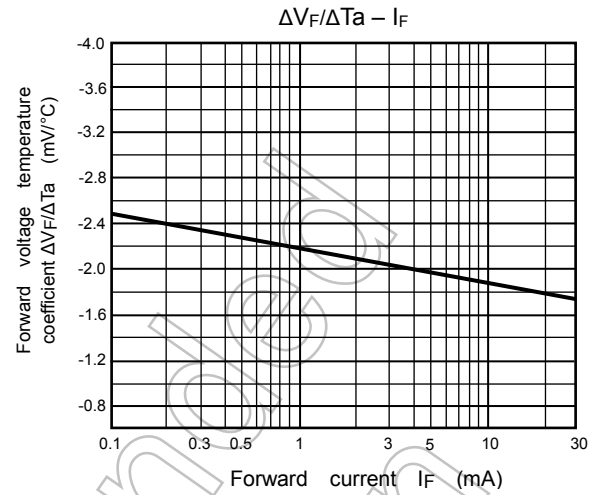
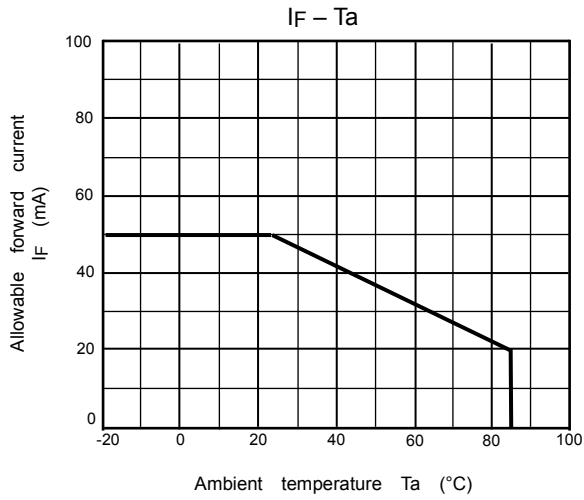
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance (input to output)	C_S	$V_S = 0 \text{ V}, f = 1 \text{ MHz}$	—	0.8	—	pF
Isolation resistance	R_S	$V_S = 500 \text{ V}, \text{R.H.} \leq 60 \%$	5×10^{10}	10^{14}	—	Ω
Isolation voltage	B_{VS}	AC, 60 s	2500	—	—	Vrms

Switching Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Turn-on time	t_{ON}	$I_F = 20 \text{ mA}, C_L = 1000 \text{ pF}$	—	0.2	—	ms
Turn-off time	t_{OFF}	(Note 2)	—	3	—	ms

Note 2: Switching time test circuit





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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